

MEL71XX Series Current Regulators

General Description

MEL71XX series is a low dropout current regulator rated for 260~350mA constant sink current.

Features

- Supply voltage range: 2.7V~6.0V ;
- 260~350mA contant sink current ;
- no external components required ;
- Low dropout voltage ;

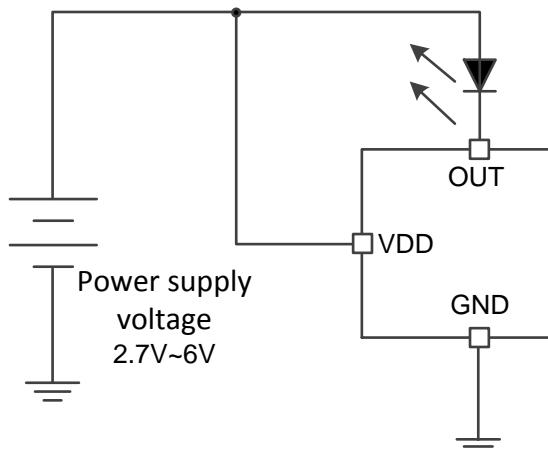
Typical Application

- Power LED driver

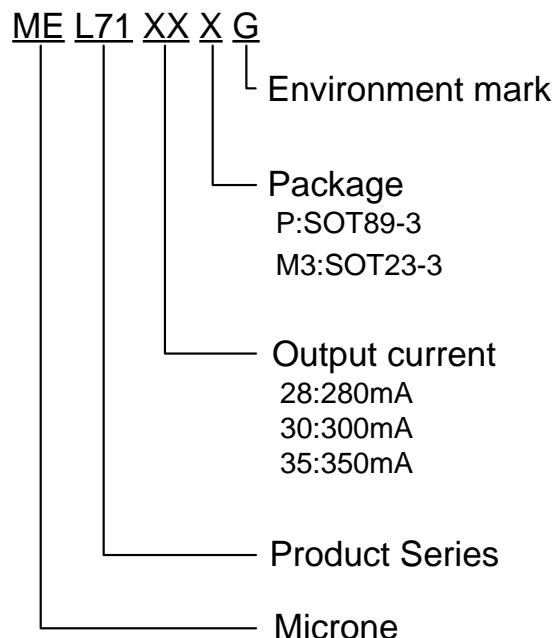
Package

- 3-pin SOT89-3、SOT23-3

Typical Application Circuit



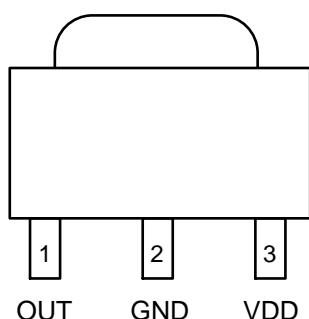
Selection Guide



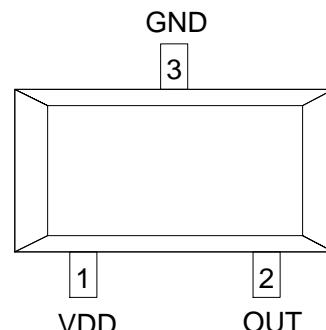
product series	product description
MEL7126PG	Output current: 260mA; Package: SOT89-3
MEL7128PG	Output current: 280mA; Package: SOT89-3
MEL7130PG	Output current: 300mA; Package: SOT89-3
MEL7132PG	Output current: 320mA; Package: SOT89-3
MEL7135PG	Output current: 350mA; Package: SOT89-3
MEL7135M3G	Output current: 350mA; Package: SOT23-3

NOTE: If you need other current or package, please contact our sales staff.

Pin Configuration



SOT89-3

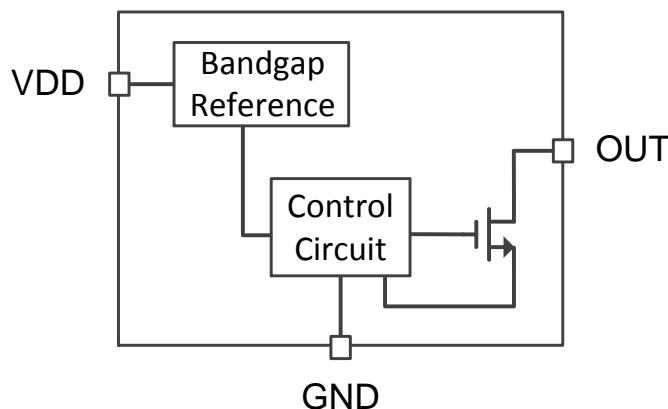


SOT23-3

Pin Assignment

Pin Number		Pin Name	Functions
SOT89-3	SOT23-3		
1	2	OUT	Output
2	3	GND	Ground
3	1	VDD	Power Input

Block Diagram



Absolute Maximum Ratings

Parameter	Symbol	Description	Unit
Input Voltage	V_{DD}	-0.3 ~ 7	V
Output Voltage	V_{LEDM}	-0.3 ~ 7	V
Operating Ambient Temperature	T_{max}	-40 ~ 150	°C
Storage Temperature	T_{stg}	-55 ~ +150	°C
Soldering Temperature And Time	T_{solder}	260°C, 10s	
Continuous Total Power Dissipation	SOT89-3	P_D	1.25
	SOT23-3		0.5
Thermal resistance	SOT89-3	θ_{JA}	100
	SOT23-3		230
			°C/W

Recommended Operating Conditions

Parameter	Symbol	Min	Typ	Max	Unit
Supply Voltage	V _{DD}	2.7		6	V
Output sink current	I _{out}			400	mA
Operating Ambient Temperature	T _a	-40		+85	°C

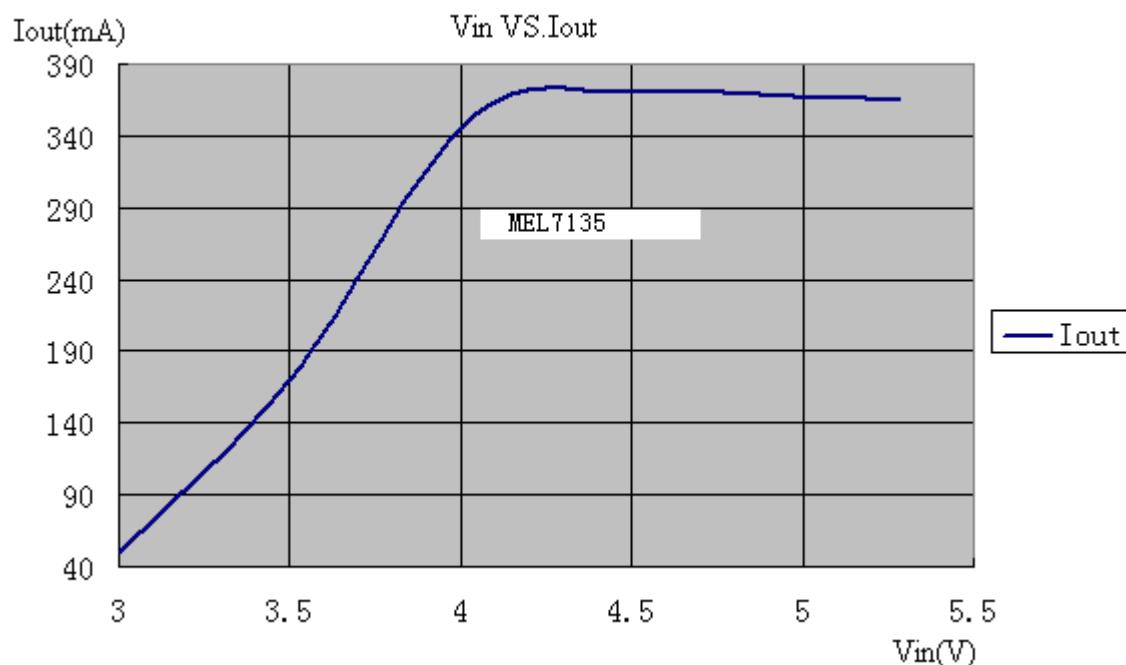
Electrical Characteristics

(V_{DD}=3.7V, T_a=25°C, No Load, unless otherwise stated)

Parameter	Symbol	Condition	Mix	Typ	Max	Unit
Output Sink Current	I _{sink}	V _{OUT} =0.2V	234	260	286	mA
			252	280	308	
			270	300	330	
			288	320	352	
			315	350	385	
Line Regulation		V _{DD} =3V~6V, V _{OUT} =0.2V			1	mA/V
Dropout Voltage	V _{OUTL}			130		mV
Supply Current	I _{DD}			90		μA

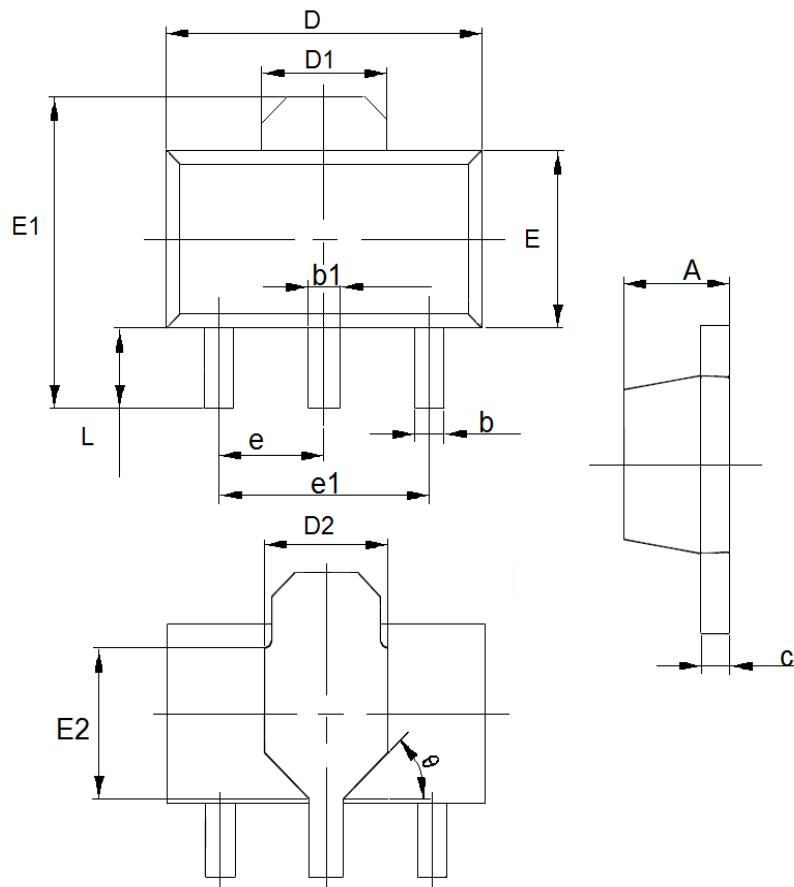
Notice1: Output dropout voltage: 90% x I_{out} @ Vout=200mv

Type Characteristics



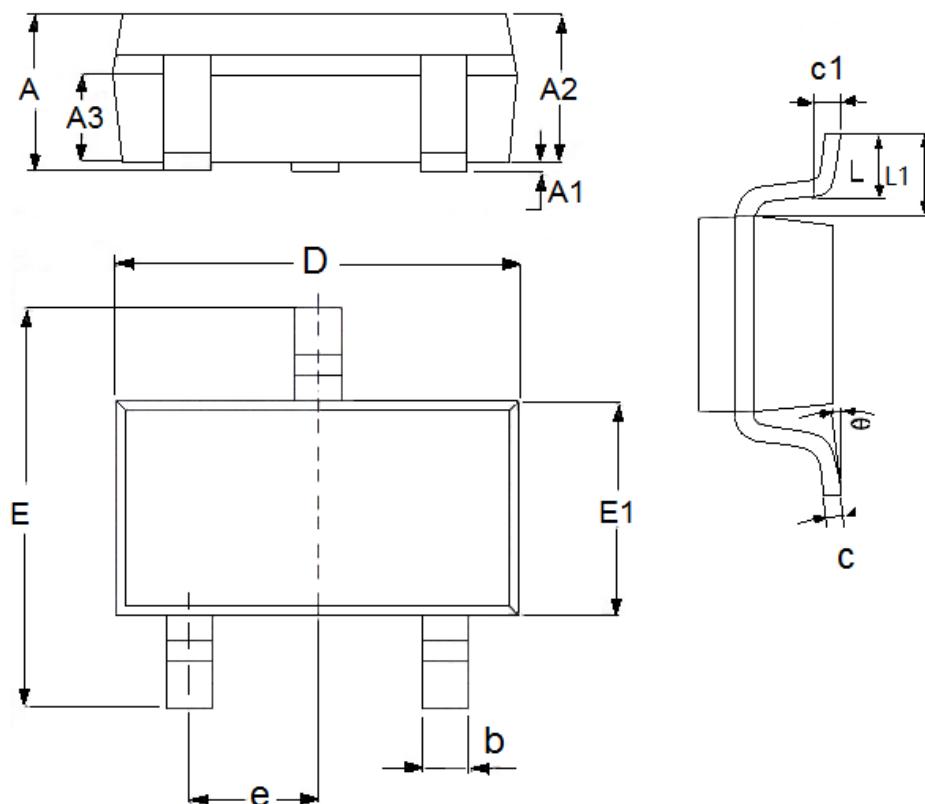
Packaging Information

- Packaging Type: SOT89-3



DIM	Millimeters		Inches	
	Min	Max	Min	Max
A	1.4	1.6	0.0551	0.0630
b	0.32	0.52	0.0126	0.0205
b1	0.4	0.58	0.0157	0.0228
c	0.35	0.45	0.0138	0.0177
D	4.4	4.6	0.1732	0.1811
D1	1.55(TYP)		0.061(TYP)	
D2	1.75(TYP)		0.0689(TYP)	
e1	3.0(TYP)		0.1181(TYP)	
E	2.3	2.6	0.0906	0.1023
E1	3.94	4.4	0.1551	0.1732
E2	1.9(TYP)		0.0748(TYP)	
e	1.5(TYP)		0.0591(TYP)	
L	0.8	1.2	0.0315	0.0472
θ	45°		45°	

- Packaging Type: SOT23-3



DIM	Millimeters		Inches	
	Min	Max	Min	Max
A	1.05	1.45	0.0413	0.0571
A1	0	0.15	0.0000	0.0059
A2	0.9	1.3	0.0354	0.0512
A3	0.6	0.7	0.0236	0.0276
b	0.25	0.5	0.0098	0.0197
c	0.1	0.25	0.0039	0.0098
D	2.8	3.1	0.1102	0.1220
E	2.6	3.1	0.1023	0.1220
E1	1.5	1.8	0.0591	0.0709
e	0.95(TYP)		0.0374(TYP)	
L	0.25	0.6	0.0098	0.0236
L1	0.59(TYP)		0.0232(TYP)	
θ	0	8°	0.0000	8°
c1	0.2(TYP)		0.0079(TYP)	

- The information described herein is subject to change without notice.
- Nanjing Micro One Electronics Inc is not responsible for any problems caused by circuits or diagrams described herein whose related industrial properties, patents, or other rights belong to third parties. The application circuit examples explain typical applications of the products, and do not guarantee the success of any specific mass-production design.
- Use of the information described herein for other purposes and/or reproduction or copying without the express permission of Nanjing Micro One Electronics Inc is strictly prohibited.
- The products described herein cannot be used as part of any device or equipment affecting the human body, such as exercise equipment, medical equipment, security systems, gas equipment, or any apparatus installed in airplanes and other vehicles, without prior written permission of Nanjing Micro One Electronics Inc.
- Although Nanjing Micro One Electronics Inc exerts the greatest possible effort to ensure high quality and reliability, the failure or malfunction of semiconductor products may occur. The user of these products should therefore give thorough consideration to safety design, including redundancy, fire-prevention measures, and malfunction prevention, to prevent any accidents, fires, or community damage that may ensue.